

LI-0040-xxxD-J

LinkIT DAC QSFP+ 40Gbps xm Juniper, Passive, xxAWG

PRODUCT FEATURES

- Compliant with SFF- 8436
- Up to 10.3125Gbps data rate per channel
- Up to 7m transmission
- Operating temperature: 0°C to +70°C
- Single 3.3V power supply
- RoHS compliant

APPLICATIONS

- Servers
- Networked storage systems
- Routers
- External storage systems
- Data Center networking



Product Description

QSFP+ Direct Attach Cables are compliant with the SFF-8436 specifications. Various choices of wire gauge are available from 30 to 24 AWG with various choices of cable length (up to 7m).

Ordering Information

| Product | Description | Cable Length (m) | AWG |
|------------------------------------|----------------|------------------|-----|
| LinkIT DAC QSFP+ 40Gbps 1m Juniper | QSFP+ to QSFP+ | 1 | 30 |
| LinkIT DAC QSFP+ 40Gbps 2m Juniper | QSFP+ to QSFP+ | 2 | 30 |
| LinkIT DAC QSFP+ 40Gbps 3m Juniper | QSFP+ to QSFP+ | 3 | 30 |
| LinkIT DAC QSFP+ 40Gbps 4m Juniper | QSFP+ to QSFP+ | 4 | 26 |
| LinkIT DAC QSFP+ 40Gbps 5m Juniper | QSFP+ to QSFP+ | 5 | 26 |
| LinkIT DAC QSFP+ 40Gbps 6m Juniper | QSFP+ to QSFP+ | 6 | 26 |
| LinkIT DAC QSFP+ 40Gbps 7m Juniper | QSFP+ to QSFP+ | 7 | 26 |
| | | | |

Note: You can be customized diameter and distance.

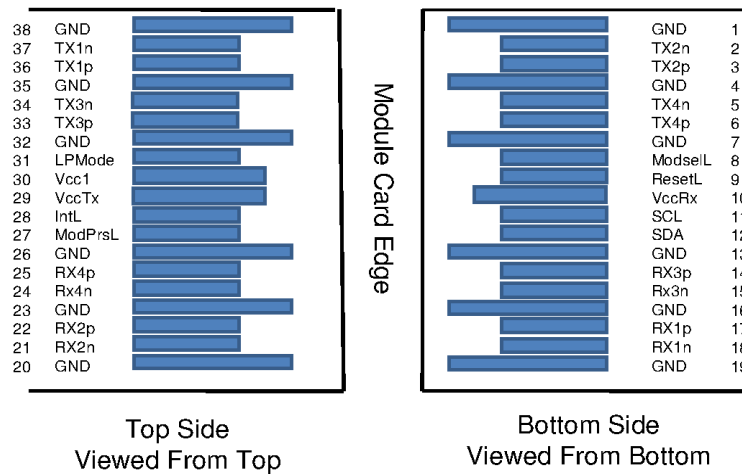
I. Absolute Maximum Ratings

| Parameter | Symbol | Min | Max | Unit | Note |
|--------------------------------------|---------|------|-----------|------|------|
| Storage Temperature | Tst | -40 | 125 | degC | |
| Relative Humidity (non-condensation) | RS | - | 85 | % | |
| Operating Case Temperature | Topc | -40 | 85 | degC | 1 |
| Supply Voltage | VCC3 | -0.3 | 3.6 | V | |
| Voltage on LVTTTL Input | Vilvttl | -0.3 | VCC3 +0.2 | V | |

II. Recommended Operating Conditions

| Parameter | Symbol | Min | Max | Unit |
|--------------------------------------|--------|-------|-------|------|
| Operating Case Temperature | Topc | -40 | 85 | degC |
| Relative Humidity (non-condensation) | RS | - | 85 | % |
| Supply Voltage | VCC3 | 3.135 | 3.465 | V |
| Power Supply Current | ICC3 | 750 | - | mA |
| Total Power Consumption | Pd | - | 2.0 | W |

III. Pin Assignments



IV. Pin Definitions

| Pin | Logic | Symbol | Description |
|-----|-------------|---------|-------------------------------------|
| 1 | | GND | Ground |
| 2 | CML-I | Tx2n | Transmitter Inverted Data Input |
| 3 | CML-I | Tx2p | Transmitter Non-Inverted Data Input |
| 4 | | GND | Ground |
| 5 | CML-I | Tx4n | Transmitter Inverted Data Input |
| 6 | CML-I | Tx4p | Transmitter Non-Inverted Data Input |
| 7 | | GND | Ground |
| 8 | LVTTL-I | ModSelL | Module Select |
| 9 | LVTTL-I | ResetL | Module Reset |
| 10 | | Vcc Rx | +3.3V Power Supply Receiver |
| 11 | LVC MOS-I/O | SCL | 2-wire serial interface clock |
| 12 | LVC MOS-I/O | SDA | 2-wire serial interface data |
| 13 | | GND | Ground |
| 14 | CML-O | Rx3p | Receiver Non-Inverted Data Output |
| 15 | CML-O | Rx3n | Receiver Inverted Data Output |
| 16 | | GND | Ground |
| 17 | CML-O | Rx1p | Receiver Non-Inverted Data Output |
| 18 | CML-O | Rx1n | Receiver Inverted Data Output |
| 19 | | GND | Ground |
| 20 | | GND | Ground |
| 21 | CML-O | Rx2n | Receiver Inverted Data Output |

| | | | |
|----|---------|---------|-------------------------------------|
| 22 | CML-O | Rx2p | Receiver Non-Inverted Data Output |
| 23 | | GND | Ground |
| 24 | CML-O | Rx4n | Receiver Inverted Data Output |
| 25 | CML-O | Rx4p | Receiver Non-Inverted Data Output |
| 26 | | GND | Ground |
| 27 | LVTTL-O | ModPrsL | Module Present |
| 28 | LVTTL-O | IntL | Interrupt |
| 29 | | Vcc Tx | +3.3V Power supply transmitter |
| 30 | | Vcc1 | +3.3V Power supply |
| 31 | LVTTL-I | LPMODE | Low Power Mode |
| 32 | | GND | Ground |
| 33 | CML-I | Tx3p | Transmitter Non-Inverted Data Input |
| 34 | CML-I | Tx3n | Transmitter Inverted Data Input |
| 35 | | GND | Ground |
| 36 | CML-I | Tx1p | Transmitter Non-Inverted Data Input |
| 37 | CML-I | Tx1n | Transmitter Inverted Data Input |
| 38 | | GND | Ground |

V. Product Characteristics

| | |
|-----------------------|------------------------|
| Number of Lanes | Tx & Rx |
| Channel Data Rate | 10.3125 Gbps |
| Operating Temperature | 0 to + 70°C |
| Storage Temperature | -40 to + 85°C |
| Supply Voltage | 3.3 V nominal |
| Electrical Interface | 38 pins edge connector |
| Management Interface | Serial, I2C |

VI. High Speed Characteristics

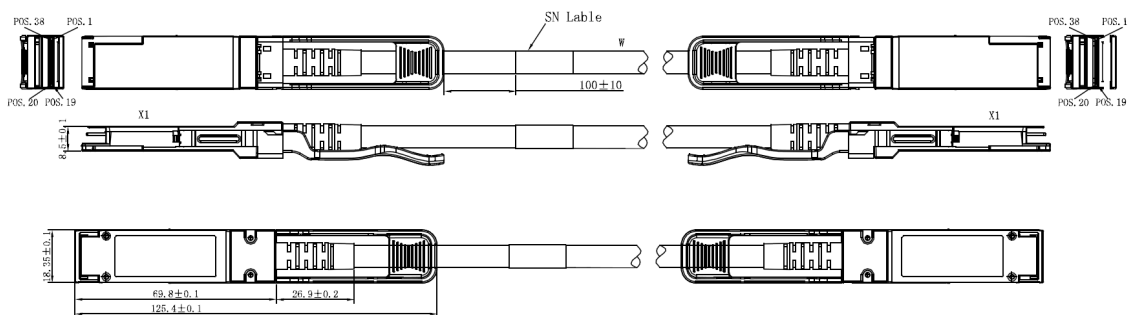
| Parameter | Symbol | Min | Typical | Max | Unit | Note |
|---|----------------|--------|---------|-------|------|--------------------|
| Differential Impedance | TDR | 90 | 100 | 110 | Ω | |
| Insertion loss | SDD21 | -17.04 | | | dB | At 5.15625 GHz |
| Differential Return Loss | SDD11 | | | See 1 | dB | At 0.05 to 4.1 GHz |
| | SDD22 | | | See 2 | dB | At 4.1 to 11.1 GHz |
| Differential to common-mode return loss | SCD11 SCD22 | | | -10 | dB | At 0.2 to 11.1 GHz |

| | | | | |
|---|----------------|----|----|---------------------|
| Common-mode to common-mode output return loss | SCC11 SCC22 | -3 | dB | At 0.01 to 11.1 GHz |
|---|----------------|----|----|---------------------|

Notes:

1. Reflection Coefficient given by equation $SDD11(dB) < -12 + 2 \times \text{SQRT}(f)$, with f in GHz
2. Reflection Coefficient given by equation $SDD11(dB) < -6.3 + 13 \times \log_{10}(f/5.5)$, with f in GHz

VII. Mechanical Diagram



Revision History

| Version No. | Date | Description |
|-------------|---------------|-----------------------|
| 1.0 | June 24, 2021 | Preliminary datasheet |

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